Single P-channel MOSFET

ELM14405AA-N

■ General description

ELM14405AA-N uses advanced trench technology to provide excellent Rds(on), low gate charge and low gate resistance.

■ Features

- Vds=-30V
- Id=-6A (Vgs=-10V)
- Rds(on) < 50m Ω (Vgs=-10V)
- Rds(on) $< 85 \text{m} \Omega \text{ (Vgs=-4.5V)}$

■ Maximum absolute ratings

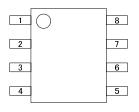
Parameter		Symbol	Limit	Unit	Note
Drain-source voltage		Vds	-30	V	
Gate-source voltage		Vgs	±20	V	
Continuous drain current	Ta=25℃	LJ	-6.0	Λ	1
	Ta=70°C	Id	-5.1	A	
Pulsed drain current		Idm	-30	А	2
Power dissipation	Ta=25℃	D4	3.0	W	1
	Ta=70℃	Pd	2.1	VV	
Junction and storage temperature range		Tj, Tstg	-55 to 150	$^{\circ}\!\mathbb{C}$	

■ Thermal characteristics

Parameter		Symbol	Тур.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	Rθja	31	40	°C/W	1
Maximum junction-to-ambient	Steady-state	Koja -	59	75	°C/W	1
Maximum junction-to-lead	Steady-state	Rθjl	16	24	°C/W	3

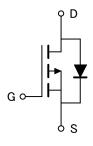
■Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name		
1	SOURCE		
2	SOURCE		
3	SOURCE		
4	GATE		
5	DRAIN		
6	DRAIN		
7	DRAIN		
8	DRAIN		

■Circuit





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■ Electrical characteristics

Ta=25℃

Parameter	Symbol	Condition		Min.	Тур.	Max.	Unit		
STATIC PARAMETERS									
Drain-source breakdown voltage	BVdss	Id=-250 μA, Vgs=0V		-30			V		
Zero gate voltage drain current	Idss	Vds=-24V				-1			
		Vgs=0V	Tj=55℃			-5	μΑ		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V				± 100	nA		
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 μ A		-1.0	-1.8	-3.0	V		
On state drain current	Id(on)	Vgs=-10V, Vds=-5V		-30			Α		
Static drain-source on-resistance	Rds(on)	Vgs=-10V			40	50	mΩ		
		Id=-6A	Tj=125℃		55	70			
		Vgs=-4.5V, Id=-4	А		65	85	m Ω		
Forward transconductance	Gfs	Vds=-5V, Id=-6A		6.0	9.5		S		
Diode forward voltage	Vsd	Is=-1A, Vgs=0V			-0.78	-1.00	V		
Max. body-diode continuous current	Is					-4.2	Α		
DYNAMIC PARAMETERS									
Input capacitance	Ciss	Vgs=0V, Vds=-15V, f=1MHz			700	840	рF		
Output capacitance	Coss				112		рF		
Reverse transfer capacitance	Crss				78		рF		
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz			10	15	Ω		
SWITCHING PARAMETERS									
Total gate charge (10V)	Qg				14.7	18.0	nC		
Total gate charge (4.5V)	Qg	Vgs=-10V, Vds=-15V, Id=-6A			7.6		nC		
Gate-source charge	Qgs				2.0		nC		
Gate-drain charge	Qgd				3.8		nC		
Turn-on delay time	td(on)				8.6		ns		
Turn-on rise time	tr	Vgs=-10V, Vds=-15V Rl=2.5 Ω , Rgen=3 Ω			5.0		ns		
Turn-off delay time	td(off)				28.2		ns		
Turn-off fall time	tf				13.5		ns		
Body diode reverse recovery time	trr	If=-6A, dl/dt=100A/μs			24.0	30.0	ns		
Body diode reverse recovery charge	Qrr	If=-6A, dl/dt=100A/ μ s			14.7		пC		

NOTE:

- 1. The value of $R\theta$ ja is measured with the device mounted on 1in^2 FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ themal resistance rating.
- 2. Repetitive rating, pulse width limited by junction temperature.
- 3. The $R\theta$ is the sum of the thermal impedance from junction to lead $R\theta$ and lead to ambient.
- 4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
- 5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics

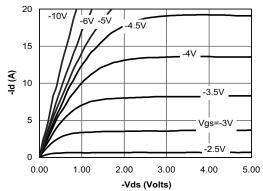


Figure 1: On-Region Characteristics

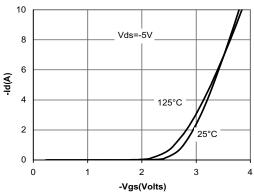


Figure 2: Transfer Characteristics

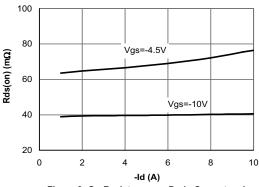


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

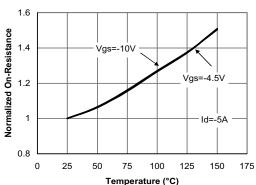


Figure 4: On-Resistance vs. Junction
Temperature

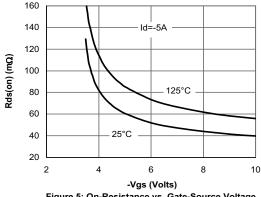


Figure 5: On-Resistance vs. Gate-Source Voltage

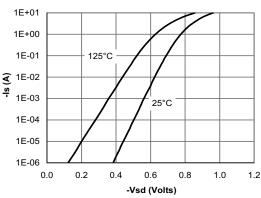


Figure 6: Body-Diode Characteristics

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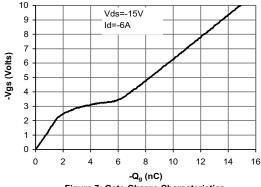


Figure 7: Gate-Charge Characteristics

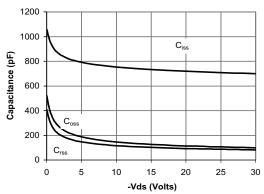


Figure 8: Capacitance Characteristics

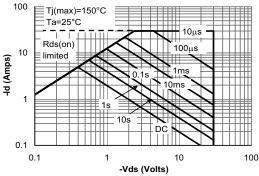


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

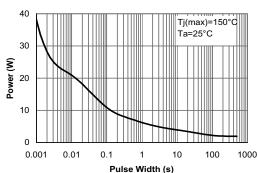


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

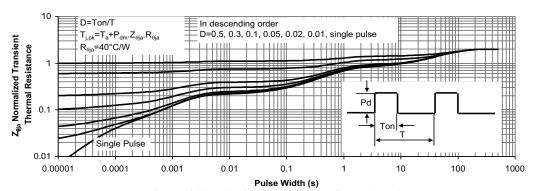


Figure 11: Normalized Maximum Transient Thermal Impedance



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